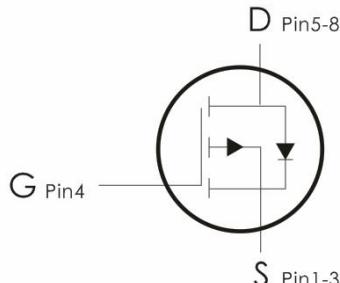
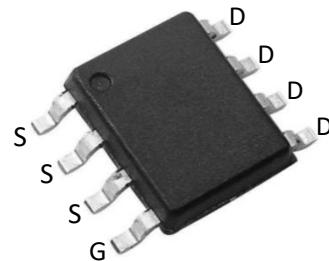


60V P-Channel MOSFET

Description:

This P-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge. It can be used in a wide variety of applications.

**Features:**

- 1) $V_{DS}=-60V, I_D=-8.5A, R_{DS(on)}<30m\Omega @ V_{GS}=-10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low $R_{DS(on)}$.
- 5) Excellent package for good heat dissipation.

Absolute Maximum Ratings: ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current- $T_C=25^\circ C$	-8.5	A
	Continuous Drain Current- $T_C=100^\circ C$	-5.4	
I_{DM}	Drain Current-Pulsed ¹	-34	A
E_{AS}	Single Pulse Avalanche Energy ²	105	mJ
I_{AS}	Single Pulse Avalanche Current ²	-46	A
P_D	Power Dissipation	4.1	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$

Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{Theta A}$	Thermal Resistance,Junction to Ambient	62	$^\circ C / W$
$R_{Theta C}$	Thermal Resistance Junction to Case	30	$^\circ C / W$

Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_D=250\ \mu\text{A}$	-60	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-60\text{V}, T_J=25^\circ\text{C}$	---	---	-1	μA
		$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-48\text{V}, T_J=125^\circ\text{C}$	---	---	-10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	± 100	nA
On Characteristics						
$V_{\text{GS(th)}}$	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_D=250\ \mu\text{A}$	-1	-1.6	-2.5	V
$R_{\text{DS(ON)}}$	Drain-Source On Resistance	$V_{\text{GS}}=-10\text{V}, I_D=-8\text{A}$	---	23	30	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_D=-6\text{A}$	---	28	40	
G_{FS}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}, I_D=-3\text{A}$	---	18	---	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	2550	3850	pF
C_{oss}	Output Capacitance		---	160	230	
C_{rss}	Reverse Transfer Capacitance		---	110	165	
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-On Delay Time ^{3,4}	$V_{\text{DD}}=-30\text{V}, V_{\text{GS}}=-10\text{V}$ $I_D=-1\text{A}, R_{\text{GEN}}=6\ \Omega$	---	25	50	ns
t_r	Rise Time ^{3,4}		---	13.8	28	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time ^{3,4}		---	148	290	ns
t_f	Fall Time ^{3,4}		---	51	100	ns
Q_g	Total Gate Charge ^{3,4}		---	43.8	88	nC
Q_{gs}	Gate-Source Charge ^{3,4}	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=-10\text{V}, I_D=-5\text{A}$	---	4.6	9	nC
Q_{gd}	Gate-Drain "Miller" Charge ^{3,4}		---	8.3	17	nC
Drain-Source Diode Characteristics						

I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	-8.5	A
I_{SM}	Pulsed Source Current		---	---	-17	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=-1A, T_J=25^{\circ}C$	---	---	-1	V
t_{rr}	Reverse Recovery Time	$V_R=-50V, I_S=-5A$	---	40	---	ns
			$dI/dt=100A/\mu s, T_J=25^{\circ}C$	---	30	---
Q_{rr}	Reverse Recovery Charge					nC

Notes:

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-46A, R_g=25\Omega$, Starting $T_J=25^{\circ}C$.
- The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

Typical Characteristics: ($T_c=25^{\circ}C$ unless otherwise noted)

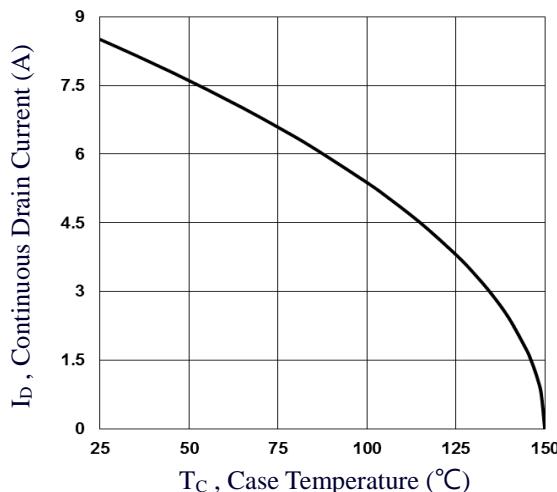


Fig.1 Continuous Drain Current vs. T_c

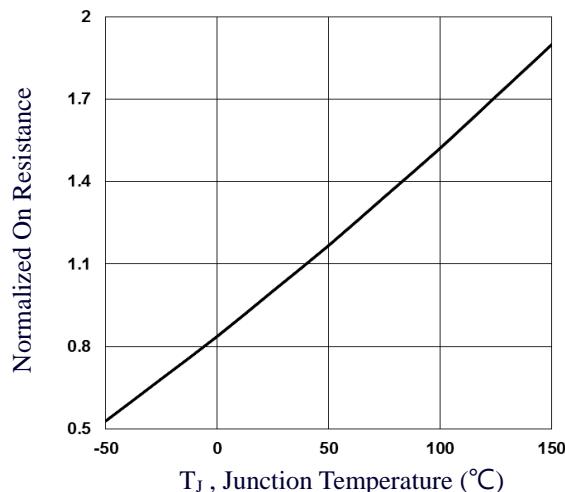


Fig.2 Normalized RDSON vs. T_J

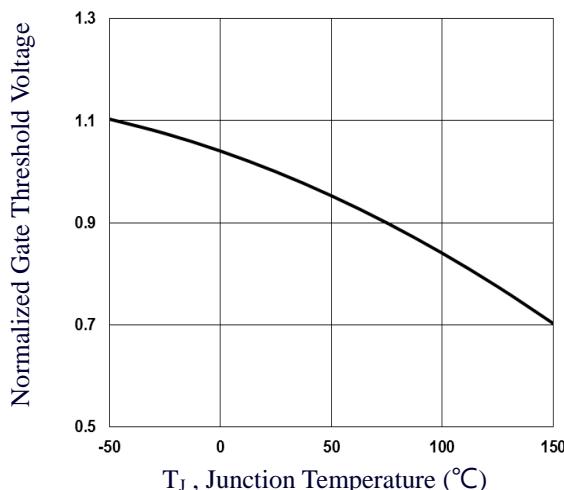


Fig.3 Normalized V_{th} vs. T_J

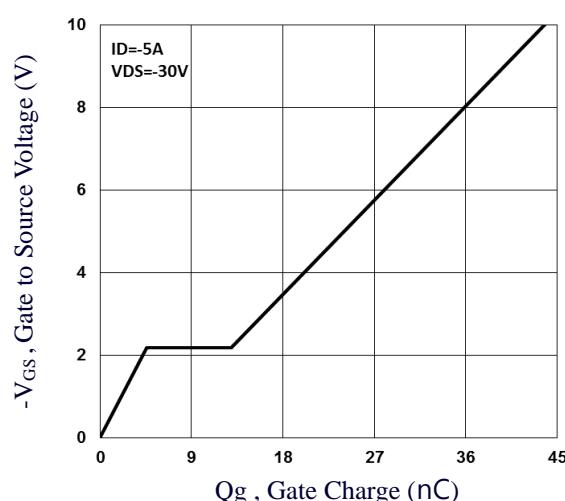


Fig.4 Gate Charge Waveform

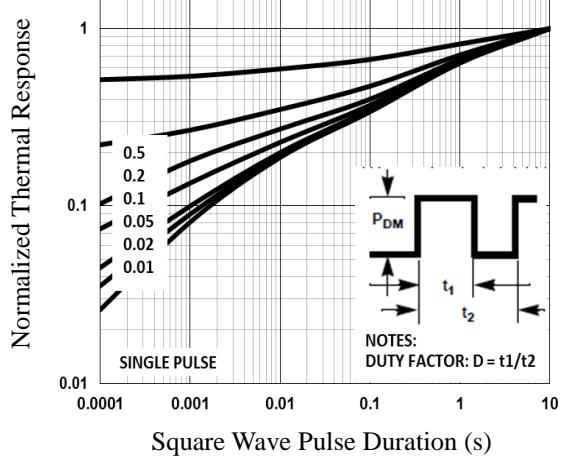


Fig.5 Normalized Transient Impedance

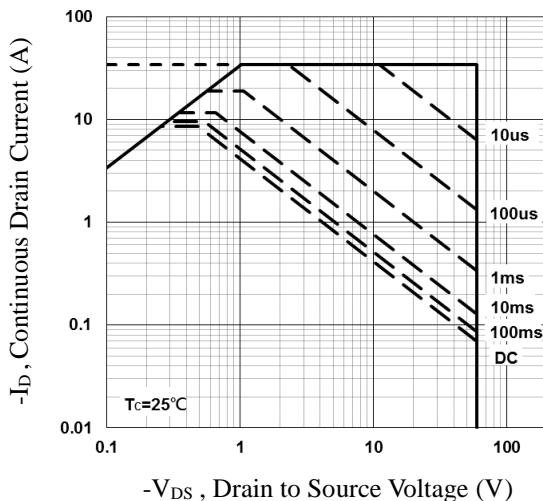


Fig.6 Maximum Safe Operation Area

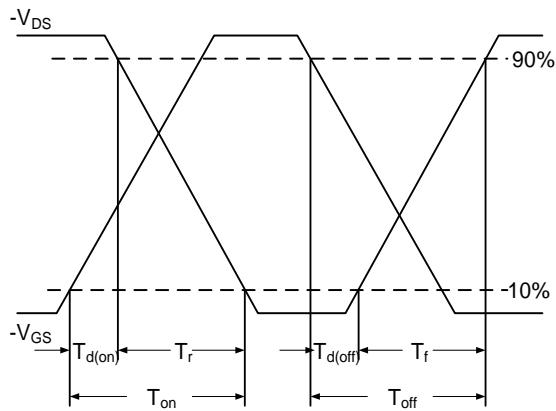


Fig.7 Switching Time Waveform

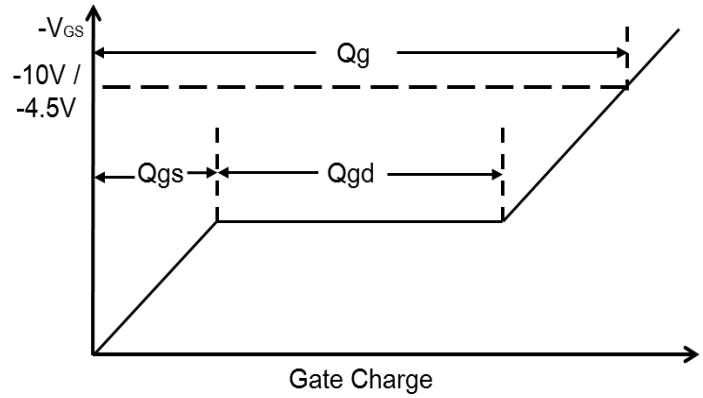
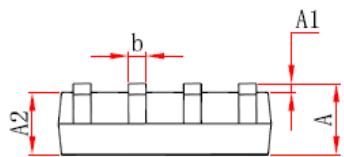
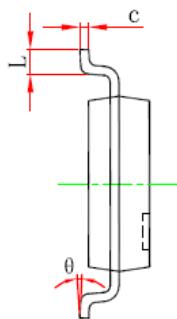
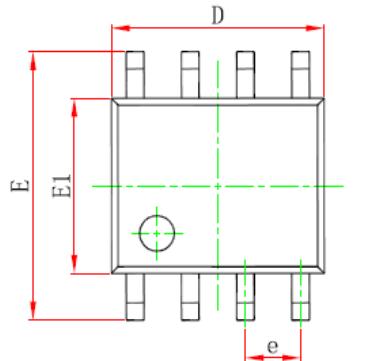


Fig.8 Gate Charge Waveform

SOP-8 Package information

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.450	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
e	1.270 (BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by SLKORMICRO manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [MCH3443-TL-E](#) [MCH6422-TL-E](#) [NTNS3A92PZT5G](#) [IRFD120](#) [IRFF430](#) [JANTX2N5237](#) [2N7000](#) [AOD464](#)
[2SK2267\(Q\)](#) [2SK2545\(Q,T\)](#) [405094E](#) [423220D](#) [MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [SSM6J414TU,LF\(T](#) [751625C](#)
[IPS70R2K0CEAKMA1](#) [BSF024N03LT3 G](#) [PSMN4R2-30MLD](#) [TK31J60W5,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#)
[EFC2J004NUZTDG](#) [FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE2384](#) [NTE2969](#) [NTE6400A](#) [DMC2700UDMQ-7](#)
[DMN2080UCB4-7](#) [DMN61D9UWQ-13](#) [US6M2GTR](#) [DMN31D5UDJ-7](#) [SSM6P54TU,LF](#) [DMP22D4UFO-7B](#) [IPS60R3K4CEAKMA1](#)
[DMN1006UCA6-7](#) [DMN16M9UCA6-7](#) [STF5N65M6](#) [IRF40H233XTMA1](#) [IPSA70R950CEAKMA1](#) [IPSA70R2K0CEAKMA1](#) [STU5N65M6](#)
[C3M0021120D](#) [DMN6022SSD-13](#)